Electronic Supplementary Material (ESI) for Phys. Chem. Chem. Phys.

Influence of Dipole and Intermolecular Interaction on the Tuning Dielectric and Energy Storage Properties of Polystyrene-Based Polymers

Qizheng Li,^a Shaobo Tan,^a Honghong Gong,^a Junyong Lu^b, Wenjing Zhang^c Xiao Zhang^{*b} and Zhicheng Zhang^{*a}

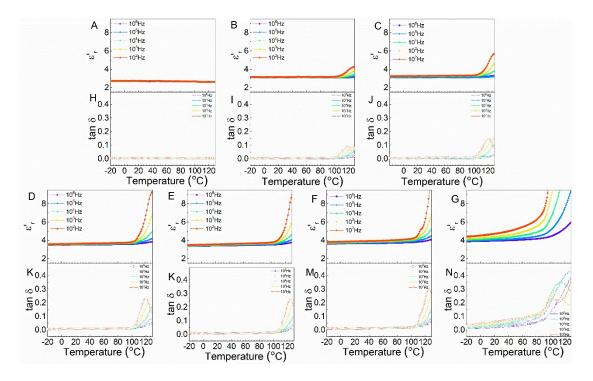


Fig. S1 Permittivity (A-G) and loss factor (H-N) as a function of temperature at different frequencies for polymers: PSt (A, H), AS-1 (B, I), AS-2 (C, J), AS-3 (D, K), AS-4 (E, L), AS-5 (F, M) and PAN (G, N).

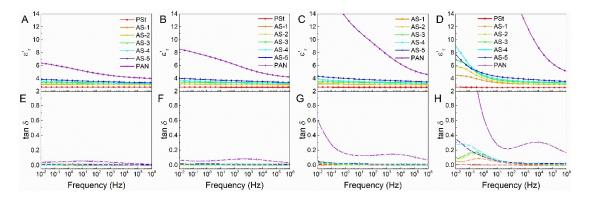


Fig. S2 Permittivity (A, B, C and D) and loss factor (E, F, G and H) of PSt, PAN and ASs, measured at 1 V bias and 20 °C (A, E), 60 °C (B, F), 90 °C (C, G), and 110 °C (D, H), respectively.

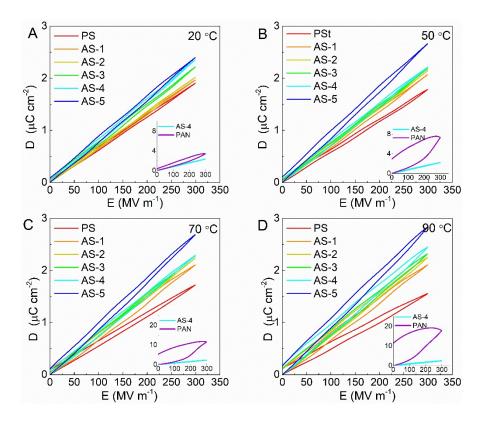


Fig. S3 Comparison of D-E loops of PSt, PAN and ASs measured at an electric field of 300 MV m⁻¹ and different temperatures of 20 °C (A), 50 °C (B), 70 °C (C) and 90 °C (D).

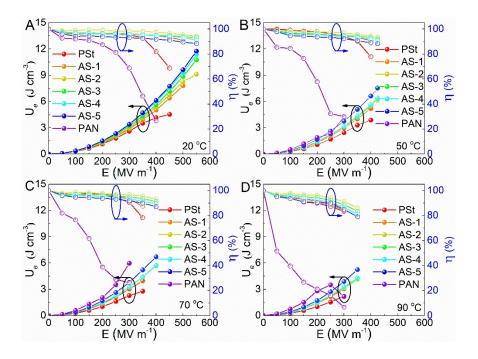


Fig. S4 Comparison of discharged energy density (U_e) and charge-discharge efficiency (η) of PSt, PAN and ASs at different electric fields and different temperatures of 20 °C (A), 50 °C (B), 70 °C (C) and 90 °C (D).

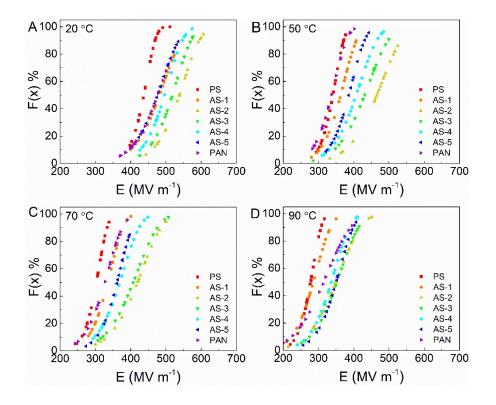


Fig. S5 Weibull distribution of the breakdown electric field of PSt, PAN and ASs with varied ratios of St/AN at 20 °C (A), 50 °C (B), 70 °C (C) and 90 °C (D).

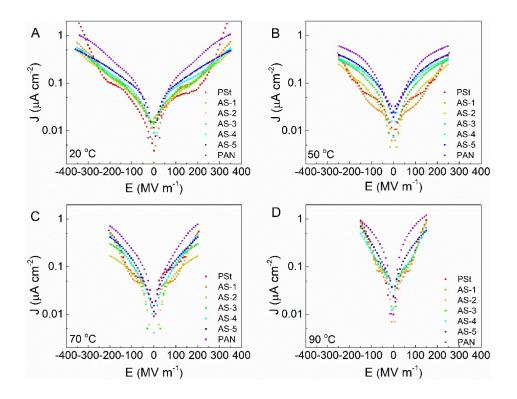


Fig. S6 Leakage current density@ 20 °C (A), 50 °C (B), 70 °C (C) and 90 °C (D) of the PSt, PAN and ASs films as a function of electric fields.

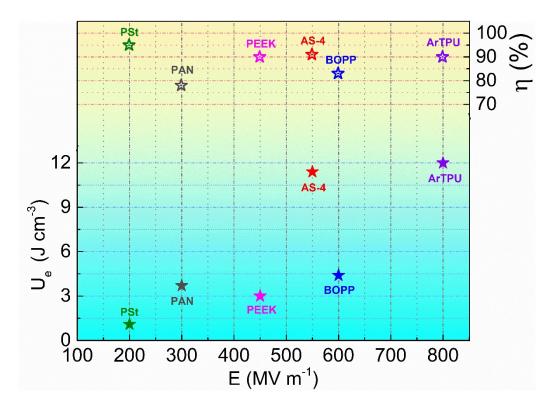


Fig. S7 The discharge energy density (U_e) and charge-discharge efficiency (η) of AS-4 compared to the-state-of-the-art dielectrics.

Polystyrene and polyacrylonitrile were commercial polymers purchased from the Innochem Company. $U_{\rm e}$ and η of PSt and PAN were measured in the same way as the AS-4 in section 3. Others come from the references.

polymers	U _{emax} (J cm ⁻³)	$\eta_{ m max}$ (%)	Ref
PP	4@600 MV m ⁻¹	87	S1
BOPP	4.4@600 MV m ⁻¹	83	S2
PP-OH	7@650 MV m ⁻¹	-	S3
SO ₂ -PPO _S	24@805 MV m ⁻¹	45	S4
ArPTU	12@800 MV m ⁻¹ -	90	S5
PTU	11@780 MV m ⁻¹	90	S3
PEEK	3.0@450 MV m ⁻¹	90	S6
PAN	3.7@300MV m ⁻¹	78	
PSt	1.1@200MV m ⁻¹	95	

Reference

- S1. M. Rabuffi and G. Picci, *IEEE Transactions on Plasma Science*, 2002, **30**, 1939-1942.
- S2. J. Wei, Z. Zhang, J.-K. Tseng, I. Treufeld, X. Liu, M. H. Litt and L. Zhu, ACS Applied Materials & Interfaces, 2015, 7, 5248-5257.
- S3. Z. Li, G. M. Treich, M. Tefferi, C. Wu, S. Nasreen, S. K. Scheirey, R. Ramprasad, G. A. Sotzing and Y. Cao, *Journal of Materials Chemistry A*, 2019, 7, 15026-15030.
- S4. Z. Zhang, D. H. Wang, M. H. Litt, L. S. Tan and L. Zhu, *Angewandte Chemie International Edition*, 2018, **57**, 1528-1531.
- S5. Y. Wang, X. Zhou, M. Lin and Q. M. Zhang, *Applied Physics Letters*, 2009, **94**, 202905.
- S6. J. Pan, K. Li, J. Li, T. Hsu and Q. Wang, *Applied Physics Letters*, 2009, 95, 022902.